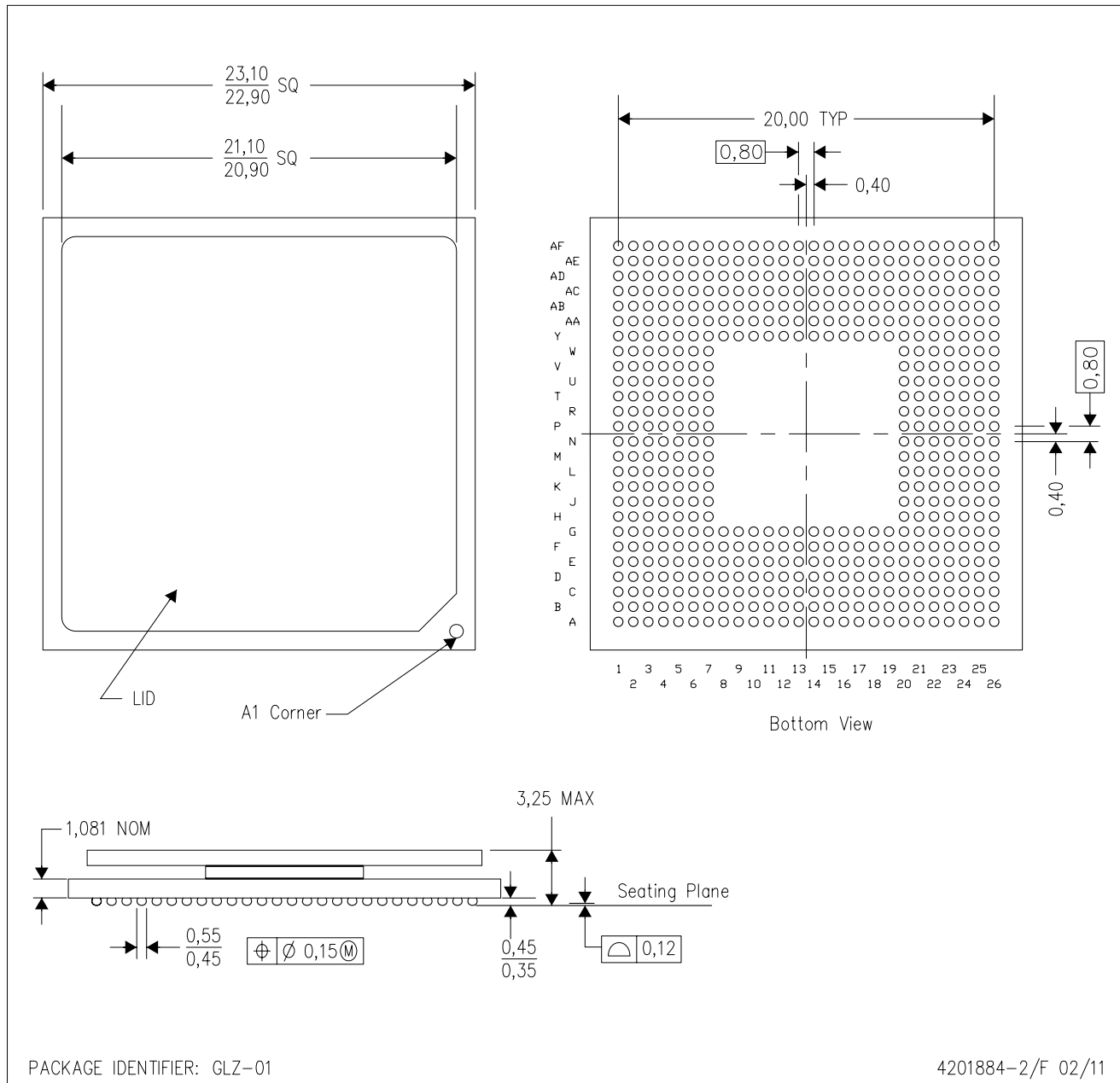


GLZ (S-PBGA-N532)

PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Thermally enhanced plastic package with a lid.
 - D. Flip chip application only.

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